

## Semico Fab Database Update Summary First Half 2014

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Below are the column headings included in the Excel workbook accompanying this Word document. There are 874 rows in the workbook:

Status	Image Sensors
Company	Oth Sensors
FabName	LED
	LED Drivers
Region	
Country	LCD Drivers
City	Other
State/ Region	Bipolar
Special Substrate	Current Process Tech (nm)
University	FinFET
Development	Wafer Size (mm)
IDM	450mm capable
Foundry	Full Capacity (w/mo)
Process Type	Full Capacity (8-in Equiv/ mo)
Products	Construction Start
Logic	Initial Prod Yr
ASSPs	Vol Prod Yr
ASICs	Yr Closed or Closing
Analog	Empl
Discretes	Total Capex (millions)
Passives	Site Size
Opto	Total Fab Size (K sq. m)
DRAM	Cleanroom Size (K sq. m)
Mobile RAM	
SRAM	
NAND	
NOR	
Other NV Memory	